

K^{3D}
SERIES

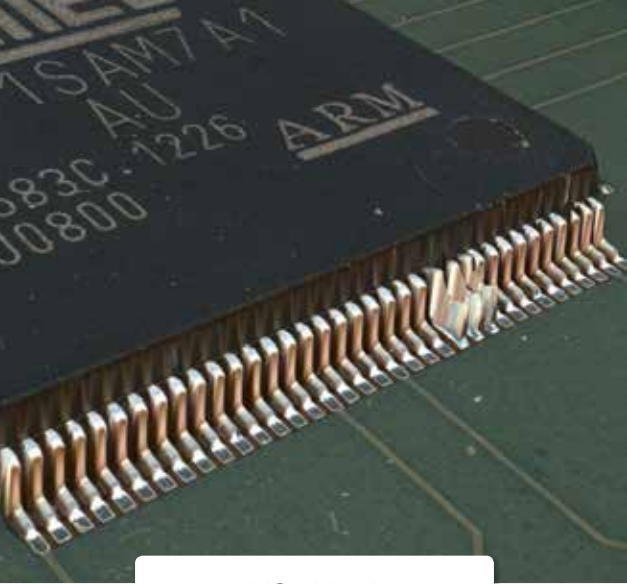
The 3D AOI solution for demanding applications



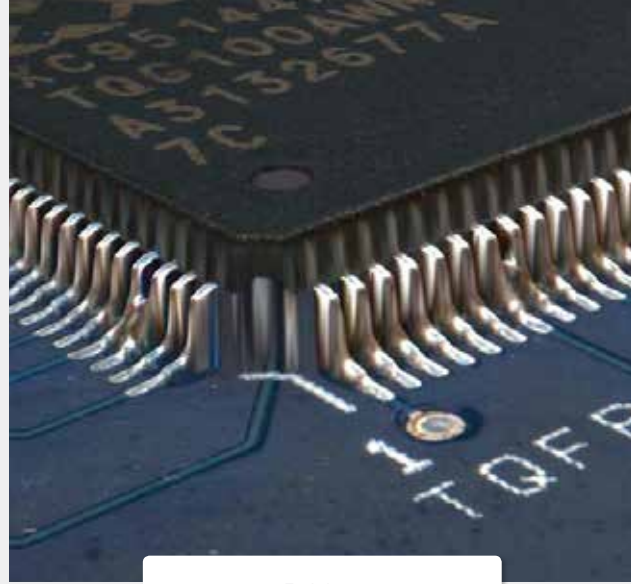
Actual images from K



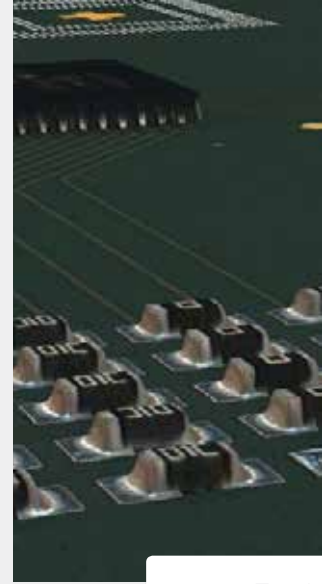
Vi TECHNOLOGY
MYCRONIC



Lifted lead

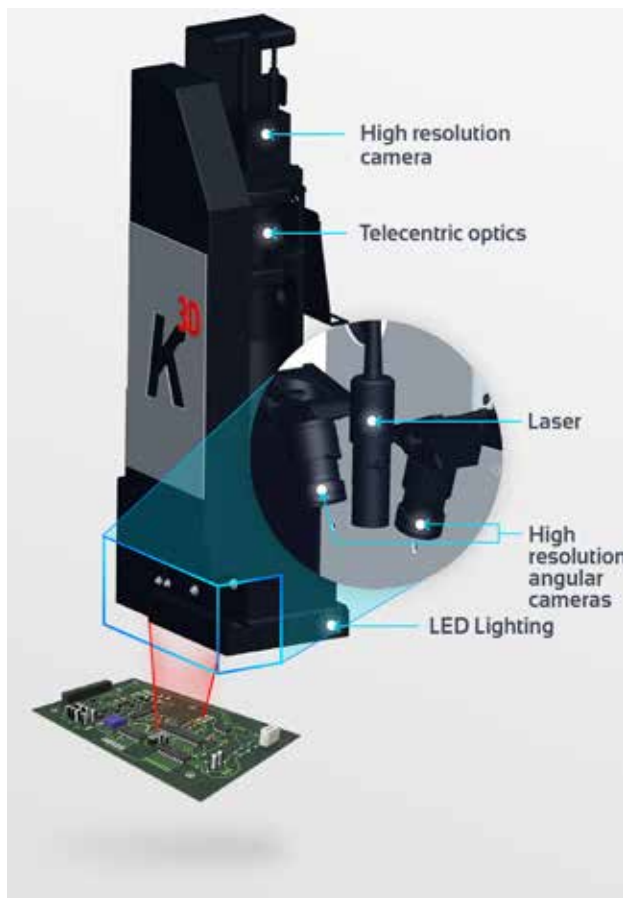


Bridge



Tomb

Expanding defect coverage boundaries using a powerful 3D AOI technology



High resolution camera with **fully telecentric** lens

High quality RGB image for inspection, portability & review

High performance **3D sensor**

Vertical laser beam to avoid projection shadow

2 x high-speed cameras to collect data from two angle views

Optimized angle to minimize intrinsic shadow effect

Adaptive height filtering to adapt 3D sensor sensitivity to component geometry

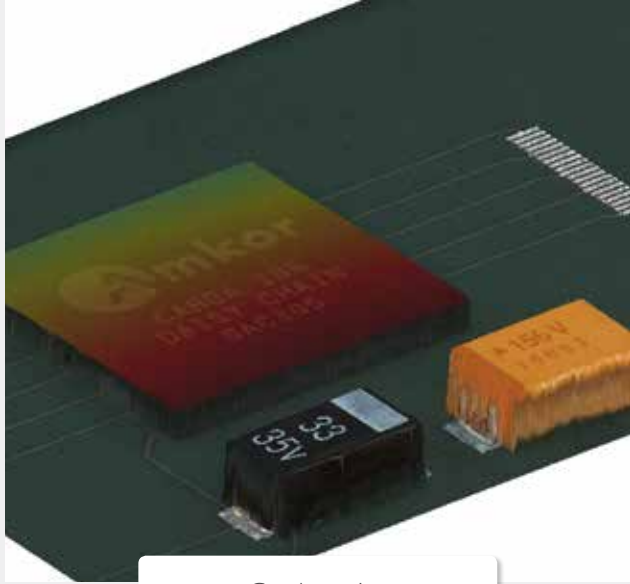
High precision motion system

3 x linear motors for high speed accurate motion

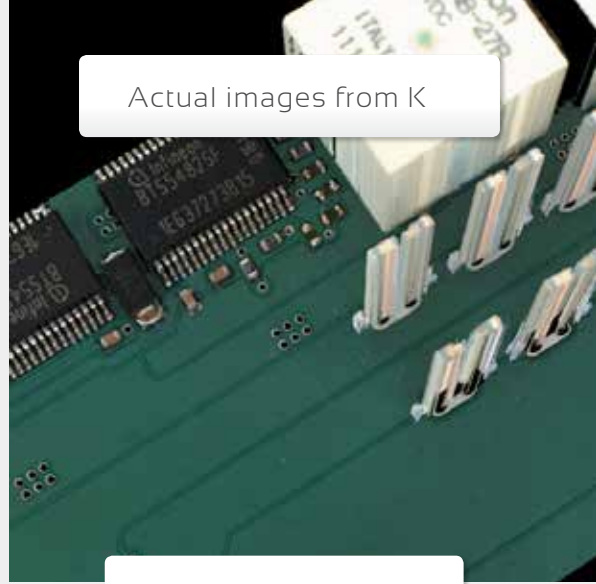
0.5 μ m resolution optical encoders for accurate positioning



Tombstone



Coplanarity



Actual images from K

Pin height measurement

Complete defect coverage



Coverage

Comprehensive defect coverage

- Component body
- Missing component
- Misplacement (X, Y, Z, θ)
- Tombstone
- Polarity
- Coplanarity
- Upside-down component
- OCR, OCV
- Solder joint
- Missing joint, solder excess
- Bridging
- Lifted lead
- Head-in-pillow
- Metrology
- Full critical measurement capability (X, Y, Z, θ)
- Foreign materials



Performance

The choice of Industry leaders

- Up time superior to 99.5%
- Very low false calls and escapes rate down to 50 ppm in production
- X, Y GRR << 4% on O1005
- Inspection time up to 100 cm²/s
- Fast programming time
- Compatibility with existing K Series libraries
- LibraryPro to guarantee performance over time
- Full program machine to machine portability
- GPU based processing
- 100% offline programming and tuning capabilities



Accuracy

High precision optical metrology system

- Shadow-free 3D sensor
- 12-bit – 8 M Pixel CCD camera
- Telecentric lens
- LED lighting with holographic diffuser
- High precision linear motors, 1 μ m repeatability, with linear optical encoders
- X,Y resolution 4.75 μ m (sub-pixel technology)
- Z constant resolution 1 μ m overs 20mm Z range
- +/- 5mm warpage compensation with full Z accuracy
- Vectoral Imaging pattern matching



Specifications

Inspection technology	Blue laser (*) with 2 angular cameras 8 M Pixel, 12-bit CCD Telecentric lens 61.1 x 44.9 mm ² (2.40" x 1.76") White, Red, Blue Axial and peripheral LED with holographic diffuser 480 000		
3D Sensor Camera Optics Field of view dimensions Lighting colors Lighting types Components inspected per hour			
System	WINDOWS 7, 64-bit Intel Core i7 8-Core, 32 GB memory 500 GB SATA3 Board and panel fiducials Linear motors with optical encoders		
Operating System Processor Storage capacity PCB positioning Motion & control			
Software Suite	Vision3D Standard based on JEDEC packages Standard Optional SIGMA Import (CAD Data) SIGMA Analysis		
Vision integrated software suite Vision library Vision Offline repair software Vision Offline programming software Offline programming software Offline SPC			
Options	Cognex DMI50, compatible with major barcode readers Yes Consult us		
External barcode reader (ID/2D) Internal barcode reader (ID/2D) Others			
PCB handling			
Conveying height	860 - 960 mm		
Minimum PCB dimensions (L x W)	2" x 2" (51x51 mm)	2" x 2" (51x51 mm)	2" x 2" (51x51 mm)
Maximum PCB dimensions (L x W)	21" x 24" (533 x 609 mm)	DL : 2 x (17" x 12,8") (2 x (432 x 325) mm) or 2 x (21" x 11,0") (2 x (533 x 280) mm) SL : 1 x (17" x 23,6") (1 x (432 x 600) mm) or 1 x (21" x 23,6") (1 x (533 x 600) mm)	21" x 24" (533,4 x 609,6 mm) 37" x 24" (option) (939 x 609 mm)
DL : <i>Dual Lane mode</i> SL : <i>Single Lane mode</i>			
PCB thickness	0.5 - 4 mm	0.5 - 4 mm	0.5 - 15 mm
Maximum PCB weight	3 kg	3 kg	15 kg
Minimum edge clearance	3 mm	3 mm	4 mm
Top clearance		34mm	
Bottom clearance		60 mm	
Facilities			
Interface	IPC-SMEMA-9851		
Power requirements	115 V / 60 Hz / 16 A, 230 V / 50 Hz / 10 A		
Dimensions (W x D x H)	1 110 mm x 1 351 mm x 1 892 mm		
Weight	900 kg		
Operation temperature	15°C to 30°C		
Relative humidity	20-75% (without condensing)		
Network	TCP/IP, RJ45 plug		
Field upgradeability			
K Series → K Series ^{3D}			

(*) K3D equipments are class I laser products, according to IEC60825-1:2014-1 standard.
Please refer to specific VITECHNOLOGY instructions regarding operation & maintenance)

HEADQUARTERS
France
Tel: +33 4 76 75 85 65

EUROPE, MIDDLE-EAST & AFRICA
sales.europe@vitechnology.com
Germany
Tel: +49 (0) 17 3206 0510

CHINA
sales.asia@vitechnology.com
Shenzhen
Tel: +86 755 8212 4147

ASEAN & OCEANIA
sales.asia@vitechnology.com
Singapore
Tel: +65 6747 6550

AMERICAS
sales.americas@vitechnology.com
United States
Tel: +1 (972) 235 1170

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www.vitechnology.com

